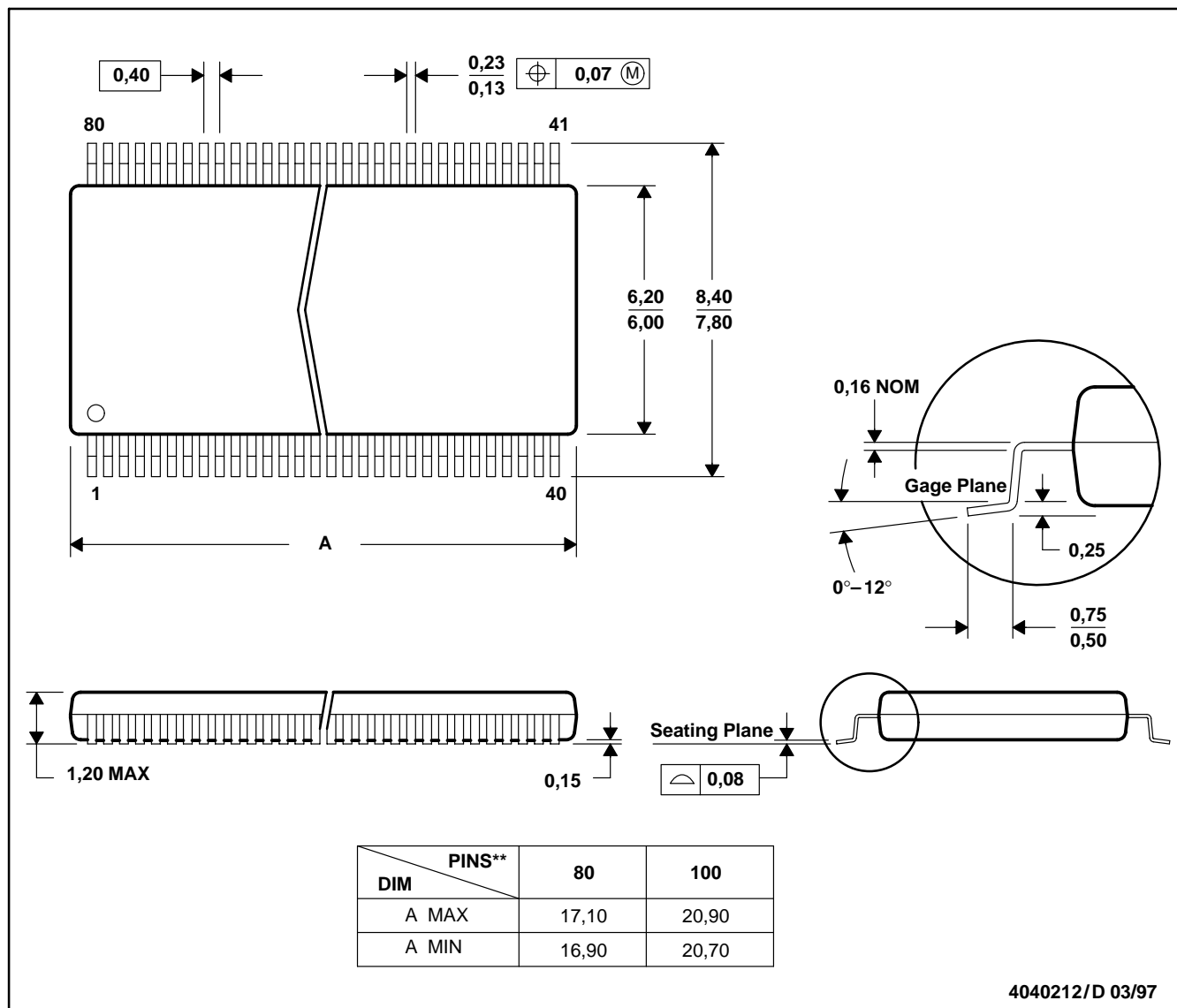


## DBB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

80 PIN SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. The 80-pin falls within JEDEC MO-153 and the 100-pin falls within JEDEC MO-194.

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